

Andor iStar sCMOS

Ultrafast Platform for Nanosecond Time-resolved Imaging and Spectroscopy

Key Specifications

- ✓ 5.5 megapixel sCMOS
- ✓ 49 fps full frame
- ✓ High dynamic range at full speed
- ✓ Integrated triple output DDG
- ✓ Photocathode QE up to 50%
- ✓ Integrate-On-Chip gating up to 500 kHz
- ✓ USB 3.0 interface

Key Applications

- Plasma studies
- Time-resolved Fluorescence & Photoluminescence
- 🗸 Flow analysis
- Combustion/PLIF imaging
- Hyperspectral imaging
- Standoff chemical detection



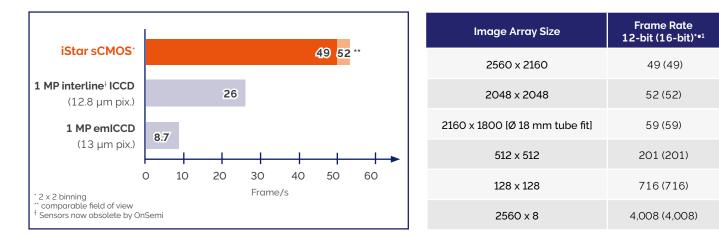
Introducing iStar sCMOS

Superior high-speed acquisition performance



- 12-bit high-speed mode
- 2 times faster than the closest interline-based competitor at an equivalent field-of-view (and over 5 times faster with ROI)

Market Leading Ultrafast Acquisition Speeds



Delivers

- Faster characterisation of transient plasma, fluorescence or absorption behaviours
- NEW Faster characterization of spectroscopic phenomena and multi point experiment studies (multi-track)
- Faster Echellogram image capture for broadband LIBSbased applications

Application Focus

Flow Analysis / Combustion

iStar sCMOS comfortably accommodates the 15 Hz imaging requirement of typical PLIF setups with extremely low noise floor and excellent dynamic range, nanosecond snapshots of the flame and high background light rejection.

Optical inter-frame down to 200 ns for time-gated PIV setups with a wide range of velocities.

Hyperspectral Imaging & multi-track spectroscopy

On-head FPGA functions can discriminate up to 256 individual channels (e.g. multi-leg fibre optic) with no acquisition rate sacrifice compared to CCDs. for time-gated PIV setups with a wide range of velocities.

Plasma Imaging

The high frame rate and < 2 ns gating of the iStar sCMOS allow faster reconstruction of plasma dynamics with extremely high temporal resolution.

Features & Benefits

Feature	Benefit
49 frames/s acquisition rates	Sustainable rate at full field-of-view, out-performs CCD and interline* based ns gated ICCDs with equivalent field-of-view.
16.6 x 14.0 mm sensor matrix	Large field of view, access more of the useful active area of Ø18 mm image intensifiers without the need for optical tapers.
2.4 e ⁻ read noise	Highest dynamic range even at the fastest frame rates, up to 5 times better performance than the closest interline-based competitor
12-bit and 16-bit modes	12-bit mode for smaller file size and absolute fastest frame rates, 16-bit for full dynamic range.
Up to 32-bit data transmission to PC	On-head intelligence to preserve dynamic range in extensive pixel binning, or high intensity pixel binning scenarios.
Optical inter-frame down to 300 ns	Ideal for PIV-type applications requiring fast dual images snapshots with high background rejection or supersonic flow analysis. The true Global Shutter mode facilitates an optical inter-frame gap down to 100 ns, although the intensifier phosphor decay time is the limiting factor. The decay time of a fast P46 phosphor is typically 200 ns (@ 10% intensity).
TE cooling down to 0°C	Efficiently minimizes dark current noise for acquisitions requiring longer sensor exposure time, e.g. integrate-on-chip mode.
High QE Gen 2 & 3 image intensifiers	Superior photon capture, with peak QE up to 50% and spectral coverage from 120 to 1,100 nm.
True optical gating < 2 ns	Billionth of a second time-resolution for accurate transient phenomena study.
Low jitter, on-board Digital Delay Generator (DDG™)	Highest gating timing accuracy with lowest propagation delay. Software controlled 3x triggering outputs with 10 ps setup accuracy for complex experiment integration.
500 kHz sustained photocathode gating (3.3 MHz Burst Mode)	Maximizes signal-to-noise ratio in high repetition rate pulse laser-based applications. Burst mode allows gate pulse separation down to 300 ns for time-resolved PIV mode.
Photocathode EBI minimization	Dry gas purge interface for further efficient EBI reduction.
Intelligate™	Intelligent and accurate MCP gating for better than 1:10 ⁸ shuttering efficiency in the UV (Gen 2 image intensifier).
USB 3.0 interface	Super-fast data transfer at 40 fps full frame with a plug-and-play, user-friendly interface – optical extenders available for operation up to 100 m.
Integrated in EPICS	Ease of operation in EPICS software-based facilities such as partner particle accelerators and other large scientific experiments.
2 year warranty	Reliability and guaranteed performance over time.
*Concors now obsolate by OnComi	

*Sensors now obsolete by OnSemi

Spectroscopy Modes

On-head asymmetric binning and multi- track	On-board intelligence delivering Spectroscopists-friendly spectra and multi-track data prior to transfer through USB interface. Upfront data size reduction and easier user data processing.
Selectable bit-depth up to 32-bit	Preserve dynamic range in extensive on-head binning scenarios. User-selectable data bit depth to be transmitted over the camera interface, up to 32-bit.

Technical Specifications^{*2}

Sensor type	Front-Illuminated Scientific CMOS				
Sensor matrix	2560 x 2160 pixels (V Ø18 mm intensifier ScMOS Sensor 1:1 coupler	W x H), 6.5 µm pixel size Ø25 mm intensifier 1:1 coupler			
Sensor size	16.6 x 14.0 mm 21.8 mm diagonal				
Pixel well depth (e ⁻)	30,000				
Read noise (e ⁻) median [rms] at available pixel readout rates ^{•3}	@ 200 MHz 2.3 [2.5] @ 560 MHz 2.4 [2.6]				
Minimum cooling temperature•4 [dark current, e [_] /pixel/s] air cooled liquid cooled	Ø18 mm photocathode Ø25 mm photocathode 0°C [0.18] 0°C [0.18] 0°C [0.18] 0°C [0.18]				
Sensor linearity (% maximum)•5	Better th	nan 99.8%			
Data range	12-bit (fastest speed) and 16-bit (maximum dynamic range)				
Pixel binning	On-head, pre-defined options 2x2, 4x4 or flexible configuration setup				
Region of Interest	Minimum channel height of 8 rows				
Interface option	USB 3.0				
Internal memory	1	GB			

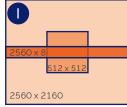
Camera and Internal Digital Delay Generator (DDG) Inputs/Outputs

Gate pulse delay & width	Gate pulse delay & width Adjustable from 0 ns to 10 s in 10 ps steps					
Trigger Outputs						
Output A, B and C	+5 V CMOS level with 50 Ω source impedance; can drive 5V into a non-terminating load or 2.5V into 50 Ω load; output synchronized triggers for auxiliary equipment, e.g. lasers, flash lamps, National Instrument™ hardware Individual delays control from 0 ns to 10 s in 10 ps steps Configurable Polarity					
Fire	5 V CMOS level reference signal for beginning and end of individual sensor exposure					
Arm monitor	5 V CMOS level reference signal to indicate when system is ready to accept external triggers. Signal goes high when system is ready to accept external triggers (after a readout has finished or sooner if in overlap mode) and goes low when the exposure is finished					
Gate & output A, B and C jitter	35 ps rms (relative to external trigger or to each other)					
	Trigger Inputs					
External trigger	Trigger input for sensor and Digital Delay Generator Up to 500 kHz for Integrate-On-Chip mode					
Direct gate	TTL input for exact external control of photocathode width and timing with smallest insertion delay.					
Additional Controls						
Gate monitoring	AC coupling from photocathode to monitor exact photocathode on/off switching and timings					
Insertion delay	< 19 ns in direct gate operation					

How the sCMOS sensor is used in the different modes

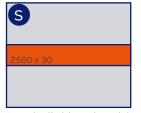
The diagrams below illustrate how the sCMOS sensor array is used for the different modes:

Imaging Mode



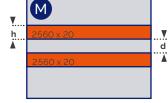
The array size may be defined for either resolution, or maximum speed.

Spectroscopy Mode



A vertically binned track is centred on the sensor enabling the maximum spectral rate to capture dynamic events.

Multi-track Mode



Up to 256 vertically binned tracks can be used for multi-track analysis without sacrificing speed.

Imaging Mode

Frame rate table - 12-bit (16-bit) *

Array Size (W x H)	Frame Rate*
2560 x 2160	49 (49)
2048 x 2048	52 (52)
1920 x 1080	97 (97)
512 x 512	201 (201)
128 × 128	716 (716)
2560 x 8	4,008 (4,008)
* O · · · O latination at	

2 x 2 binning.

Multi-track Mode

Vertically binned tracks 12-bit & 16-bit *

Number of tracks (centred vertically)	Track height (h, pixels)	Tracks separation (d, pixels)	Frame Rate
2	12	12	1,967
2	20	20	1,370
2	154	77	265
20	12	12	222
20	20	20	135
50	12	12	89
50	20	20	54
256	8	0	52

Spectroscopy Mode

Vertically binned tracks 12-bit & 16-bit"

Array Size (W x H)	Frame Rate
any x 8	4,008
any x 12	3,491
any x 16	3,092
any x 31	2,122
any x 77	1,093
any x 100	909
any x 128	736
any x 154	618
any x 462	224
any x 512	203
any x 1040	102
any x 1080	98
any x 2048	52

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Specifications: Gen 2 Image Intensifiers¹²

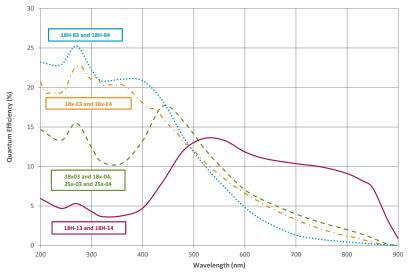
·						
Photocathode model	18*-03 (P43) 18*-04 (P46)	18*-05 ∔∙13	18H-13 (P43) • ¹³ 18H-14 (P46) • ¹³	18H-83 (P43) • ¹³ 18H-84 (P46) • ¹³	18*-E3 (P43)• ⁶ 18*-E4 (P46)• ⁶	25*-03 (P43) 25*-04 (P46)
Useful aperture	Ø18 m (Ø25 mm ave contact Ane informati	ailable- dor for	Ø18 mm only		Ø25 mm	
Input window	Quartz	MgF ₂	Quartz	Quartz	Quartz	Quartz
Photocathode type	W-AGT	W-AGT	WR	UW	WE-AGT	W-AGT
Minimum guaranteed QE at room temperature •7	13.5%	11%	7%	20%	15%	14%
Typical peak QE at room temperature•7	18%	15%	13.5%	25%	22%	16%
Wavelength range (nm)	180 - 850	120 - 850	180 - 920	180 - 850	180 - 850	180 - 850
Phosphor type [decay time to 10%] Standard Optional**	P43 [2 ms] P46 [200 ns]					
Image intensifier resolution limit •8 P43 (Standard) P46 (Optional)	25 μm 30 μm [-04 model]	25 μm 30 μm	25 μm 30 μm [-14 model]	25 μm 30 μm [-84 model]	25 μm 30 μm [-E4 model]	35 μm 40 μm [-04 model]
Minimum optical gate width (ns) •9.10 U (Ultrafast) F (Fast) H (High QE)	< 2 < 5 -	< 5 < 10 -	- - < 50	< 100	< 2 < 5 -	< 3 < 7 -
Maximum relative gain 배	> 1000 (P43) > 500 (P46)	> 1000	>850 (P43) >400 (P46)	>500 (P43) >250 (P46)	>300 (P43) >150 (P46)	>1000 (P43) >500 (P46)
Maximum photocathode repetition rate (with Intelligate™ OFF)	500 kHz (continuous)					
Maximum photocathode repetition rate n(with Intelligate™ ON)		5 kHz (continuous)				
Equivalent Background Illuminance (EBI)	< 0.2 photoe ⁻ ,	.2 photoe ⁻ /pix/sec <0.2 photoe ⁻ /pix/sec <0.2 photoe ⁻ /pix/sec				

* Substitute with appropriate gate width option, e.g. 18*-03 (please refer to page 9 for detailed ordering information)

** All photocathode types can be combined with a fast-decay P46 phosphor – please contact your local Andor representative for further information

⁺Comes with an O ring VUV-compatible spectrograph interface as standard

Quantum Efficiency Curves for Gen 2 Image Intensifiers"



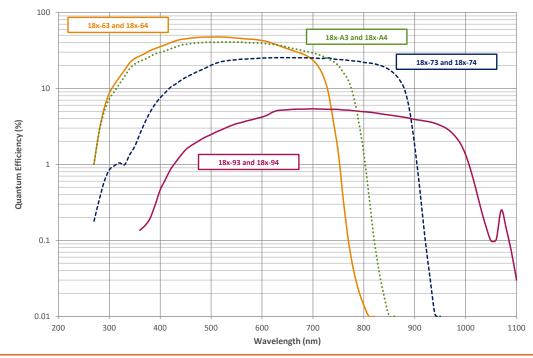
Specifications: Gen 3 Image Intensifiers¹²

Photocathode model	18*-63 (P43) 18*-64 (P46)	18*-73 (P43) 18*-74 (P46)	18*-93 (P43) • ¹³ 18*-94 (P46) • ¹³	18*-A3 (P43) 18*-A4 (P46)	
Useful aperture	Ø18 mm (Ø25 mm options also available except -93 model- contact Andor for information				
Input window	Glass	Glass	Glass	Glass	
Photocathode type	HVS	VIH	NIR	EVS	
Minimum guaranteed QE at room temperature •7	38%	23%	0.10%	35%	
Typical peak QE at room temperature •7	50%	30%	5%	40%	
Wavelength range	280 - 760 nm	280 - 910 nm	380 - 1090 nm	280 - 810 nm	
Phosphor type [decay time to 10%] Standard Optional**	P43 [2 ms] P46 [200 ns]				
Image intensifier resolution limit • ⁸ P43 (Standard) P46 (Optional)	30 µm 35 µm [-64 model]	30 μm 35 μm [-74 model]	30 µm 35 µm [-94 model]	30 μm 35 μm [-A4 model]	
Minimum optical gate width (ns) •10 U (Ultrafast) F (Fast)	< 2 < 5	< 2 < 5	< 3 < 5	< 2 < 5	
Maximum relative gain •11	> 200 (P43) > 100 (P46)				
Maximum photocathode repetition rate (with Intelligate™ OFF)	500 kHz (continuous)				
Maximum photocathode repetition rate (with Intelligate™ ON)	5 kHz (continuous)				
Equivalent Background Illuminance (EBI)	< 0.1 photoe ⁻ /pix/sec	< 0.3 photoe ⁻ /pix/sec	< 2 photoe ⁻ /pix/sec	< 0.2 photoe ⁻ /pix/sec	

* Substitute with appropriate gate width option, e.g. 18*-63 (please refer to page 9 for detailed ordering information)

" All photocathode types can be combined with a fast-decay P46 phosphor – please contact your local Andor representative for further information

Quantum Efficiency Curves for Gen 3 Image Intensifiers^{•7}

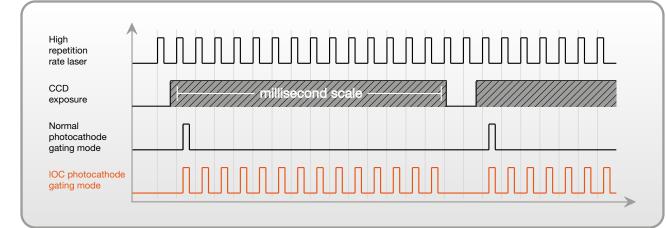


Intelligent gating modes

Integrate-On-Chip: 500,000 times more signal per 1 sec sensor exposure

The iStar's Integrate-On-Chip (IOC) mode enables accumulation of useful signal from laser-induced phenomena at frequencies up to 500 kHz, providing greatly improved signal-to-noise, and minimising experiment time. The latter greatly benefits setups where photobleaching-sensitive biological samples are probed. This translates into the possibility to accumulate 500,000 times more signal per 1 second sensor exposure time.

Integrate-On-Chip is fully software-configurable and can be used through extensive kinetic series involving up to 1,000 pre-programmed incremental delays from laser trigger for unrivalled combination of sensitivity and ultra-precise transient phenomena analysis.



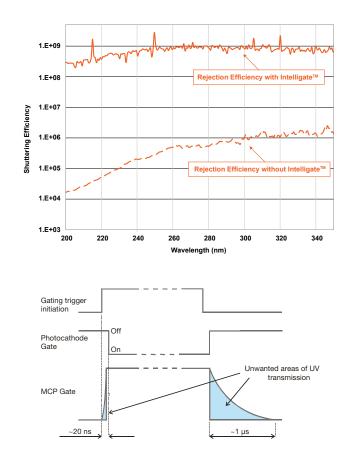
IntelligateTM: Superior gating in the UV-VUV region

One of the key functions of an image intensifier is to provide high optical shuttering (ON/OFF) ratio.

By switching photocathode voltage to a higher or lower level relative to the MCP voltage, photoelectrons can be either directed towards or repelled from the MCP to avoid detection. ON/OFF values of 1:10⁸ are typically measured for Visible/NIR incident light on the photocathode.

However photocathode "leakage" becomes more pronounced in the UV-VUV region (< 300 nm), where more energetic photons have a greater probability to go through the photocathode turned "OFF", reach the MCP to generate an electron that can be detected. This can lead to shuttering efficiency as low as 1:10⁴.

Andor's exclusive Intelligate[™] simultaneously gates the photocathode and the MCP. The ultra fast rising edge of the MCP gate pulse switches on the correct potential in a nanosecond timeframe, coinciding precisely with the photocathode gating pulse. This enables ON/OFF ratios as high as 10⁸ in the UV-VUV region.



Creating the optimum product for you

	ISTAR-	SCMOS	5-(18)(- (03	example sho	wn	
Step 1.	Choose the intensif	ier diamet	er S	Step 2.	Choose a m	inimum ga	ting speed
Intensifier Diameter	Intensifier diameter Ø 18 mm Ø 25 mm Please contact Andor regardi options.	18 25		Gating Speed	Gating s High QE, sla Fast Ga Ultra Fast	ow gating ating	Code H F U
Step 3. S	elect an image inten	sifier optio	on				
	Gen 2 Intensifier option	P43 phosphor	P46 phosphor	Gen 3 Int	ensifier option	P43 phosphor	P46 phosphor
	W-AGT photocathode	03	04	HVS p	hotocathode	63	64
	WE-AGT photocathode	E3	E4	VIH p	hotocathode	73	74
Intensifier				EVS p	hotocathode	A3	A4
	lease contact Andor regarding	the 05, 13, 14,	83, 84, 93 and 9		VE-AGT iers.	E3	E4
Step 4. S	elect the required ac	cessories	and adapt	ers			
		Des	cription			Or	der Code
			t lens adaptor			A	CC-LM-C
		F-mount	t lens adaptor			ACC-I	LM-NIKON-F
	UV-VIS 105m	m SLR lens, 25	0 - 650 nm trans	mission, F-mour	nt	OL-AF1	LO-F45-#UV2
	Oasis 160 Ultra c	compact chiller	unit (tubing to be	e ordered separc	itely)	ACC-X	W-CHIL-160
ccessories & Adapters	6 mr	0 1	ns for ACC-XW-C r 2x5 m lengths)	HIL-160			-TUBING-2X2. 1-TUBING-2X5
Adupters	I ² C to BNC of	cable for Kyme	ra and Shamrock	shutter control		EL	C-05323
			¹ ⁄4-20 mounting			ACC-IST/	AR-METRIC ADI
			or cable (power s				ASE-06887
			Ider solution inclu			ACC-	ASE-08762
	100 m fibro onti	CLISP 20 ovtor	nder solution incl	udina na autor auto	volu	100	ASE-07860

Step 5. Select the required software

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The iStar sCMOS requires at least one of the following software options:

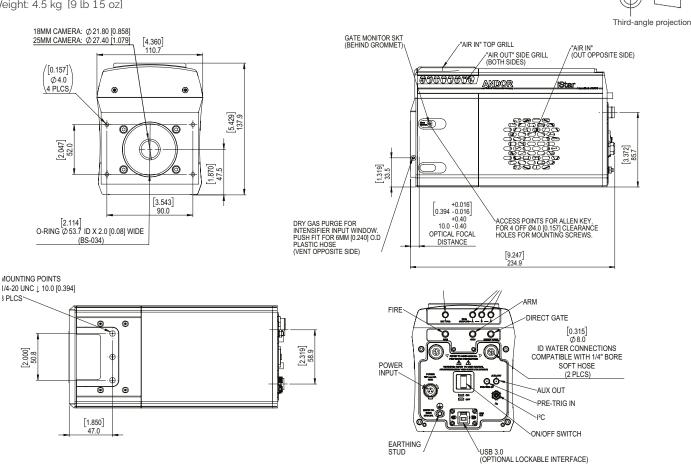
Solis for Time-Resolved A 32-bit and fully 64-bit enabled application for Windows (8.1, 10 and 11) offering rich functionality for data acquisition and processing. AndorBasic provides macro language control of data acquisition, processing, display and export.

Andor SDK3 A software development kit that allows you to control the Andor range of cameras from your own application.
 Software Available as 32/ 64-bit libraries for Windows (8.1, 10 and 11) and Linux. Compatible with C/C++, C#, Delphi, VB.NET, LabVIEW, MATLAB and Python.

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Product drawings

Dimensions in mm [inches] Weight: 4.5 kg [9 lb 15 oz]



Connecting to the iStar sCMOS

Camera Control

Connector type: USB 3.0^{•12}

Logic Input / Output

Connector type: SMA, provided with SMA - BNC cable

6x outputs: FIRE pulse, Output A, B, C from DDG, ARM, and Aux Out. 3x inputs: Camera trigger from 3rd party source (External Trigger), direct gate for direct external control of intensifier gating, and Pre-Trigger

I²C connector

Compatible with Fischer SC102A054-130, pin-outs as follow:

1 = Shutter (5V CMOS level with 50 Ω impedance), 2 = I²C Clock (5 V), 3 = I²C Data (5 V), 4 = +5 Vdc, 5 = Ground

Gate Monitor

1x output: AC coupling to photocathode

Aux Out (external mechanical shutter output)

Configured by default to a 5 V CMOS level with 50Ω impedance shutter output for controlling Andor Shamrock spectrograph mechanical shutters **Pre-trigger**

Controls the sensor exposure in 'external exposure mode'. Also available in 'external trigger mode' as a optional exclusive trigger to the sensor.

Regulatory Compliance & Power Supply Information

Regulatory Compliance

- RoHS compliant
- EU EMC Directive
 EU LV Directive
- IEC 61010-1 CB Scheme

External Power Supply Compliance

- UL-certified for Canada and USA
- Japanese PSE Mark

Power Supply Requirements

- Power: +12 VDC ± 5% @ 5 A typ. / 9 A max.
- Ripple: 120 mV peak-peak 0 20 MHz
 100 240 VAC, 43 67 Hz External power supply
- Power Consumption:
- Camera + External Power Supply (Typ./ Max.): 69 W/ 124 W
- Camera Only (Typ./ Max.): 60 W/ 108 W

Our Cameras for Spectroscopy

Spectroscopy-based diagnostics in the fields of Material Science, Chemistry, Life Science or Fundamental Physics & Optics rely on the capture and analysis of optical and chemical signatures with a high degree of precision.

Andor's range of detectors offer a wide range of sensitivity, time-resolution and sensor formats to best suit specific experimental conditions from UV to SWIR, nanosecond to hours time resolution, high photon flux to single photon with super dynamic range and resolution.

High Sensitivity & Dynamic Range



- ✓ Long exposure
- High sensitivity UV-SWIR
- Large pixel well depths
- High resolution matrix

iDus CCD & InGaAs Newton CCD & EM

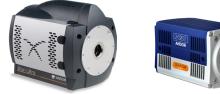
Spectrographs & Accessories



- High modularity
- \checkmark High resolution
- Intelligent motorisation
 - Broadband & high resolution Echelle

Shamrock | Kymera | Mechelle

kHz Spectral Rates



- ✓ µs to ms time-resolution
- High sensitivity down to single photon
- High resolution matrix

Newton CCD & EMCCD | iXon EMCCD | ZL41 sCMOS | Marana sCMOS

Extended Multi-fibre Spectroscopy



- ✓ Large area sensors
- ✓ Ultrafast sCMOS and EMCCD options
- ✓ High sensitivity down to single photon

iKon-M CCD | iXon EMCCD | ZL41 sCMOS | Marana sCMOS | iStar CCD & sCMOS

Learn more about our detector range here.





Order Today

Need more information? At Andor we are committed to finding the correct solution for you. With a dedicated team of technical advisors, we are able to offer you one-to-one guidance and technical support on all Andor products. For a full listing of our local sales offices, please see: andor.oxinst.com/contact

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Japan

Tokyo Phone +81 (3) 6744 4703 Fax +81 (3) 3446 8320

China

Beijing | Shanghai | Guangzhou Phone +86 (400) 678 0609 Fax +86 (10) 5884 7901



Items shipped with your camera

- (Type A to B)
- 1x Gate Monitor cable 2x 2 m BNC to SMA cable
- 1x Power supply with mains cable
- 1x Quick Start Guide
- 1x User guides in electronic format

1x Individual perfomance booklet

- **Minimum Computer Requirements:**
- 3 GHz Quad Core 4GB RAM (increase RAM if to be used for
- continuous data spooling) Hard Drive: Minimum 450 MB/s continuous
- write
- PCI Express x4 or greater
- Windows (8.1, 10 and 11) or Linux
- *See technical note entitled: 'PC Specifications

Operating and Storage Conditions

- Operating Temperature:0°C to 40°C ambient
- Relative Humidity: < 70% (non-condensing)
- Storage Temperature: -20°C to 55°C

Power Requirements

Please refer to page 10

- Footnotes: Specifications are subject to change without notice
- 1 x USB 3.0 PCle Card and 1 x 3 m USB 3.0 cable 1. Note that the write speed of the PC hard drive can impose a further restriction to achieving sustained kinetic series
 - acquisition. All frame rates specified are given for non-overlap mode.
 - 2. Figures are typical unless otherwise stated.
 - 3. Readout noise is for the entire system and is taken as a median over the sensor area excluding any regions of blemishes. It is a combination of sensor readout noise and A/D noise.
 - 4. Dark current measurement is taken as a median over the sensor area excluding any regions of blemishes.
 - 5. Linearity is measured from a plot of Signal vs. Exposure Time over the full dynamic range.
 - 6. The On/Off ratio for the 'E3 and E4' image intensifier in the UV with MCP gating is typically 10⁵.
 - 7. Typical photocathode Quantum Efficiency and input window transmission as measured by the tube manufacturer.
 - 8. Typical resolution of the image intensifier tube only, not the overall resolution of the system. As a rough guide, the smallest resolvable FWHM feature will be approximately 4x the sensor pixel size. This is a very important consideration for optical resolution calculations in spectrograph-based systems.
 - 9. Gen 2 High QE (H) option Photocathode QE is inherently linked to the gating speed of the intensifier. High QE option (H) offers higher peak QE than Ultrafast (U) or Fast (F) intensifiers, while exhibiting minimum gating speed one order of magnitude slower
 - 10. Actual measured minimum optical gating of the photocathode, reflecting not only the electrical pulse width applied to the photocathode but also its inherent irising time.
 - 11. Gain is software-selectable through a 12-bit DAC and varies exponentially with DAC setting. Value refers to the ratio of max to min intensifier gain as measured for individual cameras. Actual optical gain (counts/photoe) for a DAC setting is accessed by the multiplication of the relative gain (at that DAC value) by the minimum system gain (at DAC = 0, sCMOS e / photoe) and divided by the sCMOS sensitivity (sCMOS e /count). Sensitivities are individually measured and reported for each system.
 - 12. USB 3.0 connection should work with any modern USB 3.0 enabled PC/laptop (provided hard drives or RAM is sufficient to support data rates) as every USB 3.0 port should have its own host controller. IStar sCMOS also ship with a USB 3.0 PCIe card as a means to add a USB 3.0 port to an older PC, or as a diagnostic aid to interoperability issues or to ensure maximum speed.
 - 13. 18'-05, 18H-13 and 18H-14, 18H-83 and 18H-84, 18'-93 and 18'-94 image intensifiers are available through our Customer Special Request process - please contact your sales representative



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